

MOSFET

OptiMOS[™] 5 Power-Transistor, 80 V

Features

- Optimized for synchronous rectification
 Very low on-resistance R_{DS(on)}
 100% avalanche tested

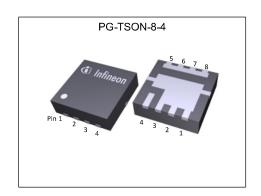
- Superior thermal resistance
- N-channel, normal level
- Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21

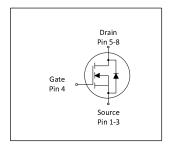
Product validation

Fully qualified according to JEDEC for Industrial Applications

Kev Performance Parameters Table 1

Parameter	Value	Unit
V _{DS}	80	V
R _{DS(on),max}	5.0	mΩ
I _D	101	Α
Q _{oss}	40	nC
Q _G (0V10V)	35	nC











Type / Ordering Code	Package	Marking	Related Links
IQE050N08NM5	PG-TSON-8-4	05008N5	-

OptiMOS[™] 5 Power-Transistor, 80 V



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OptiMOS[™] 5 Power-Transistor, 80 V **IQE050N08NM5**



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 **Maximum ratings**

Parameter	Cumb al	Values				N
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D	- - -	- - -	101 71 16	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10V, $T_{\rm A}$ =25°C, $R_{\rm thJA}$ =60°C/W ²⁾
Pulsed drain current ³⁾	I _{D,pulse}	-	-	404	Α	<i>T</i> _A =25 °C
Avalanche energy, single pulse ⁴⁾	E _{AS}	-	-	184	mJ	I_D =20 A, R_{GS} =25 Ω
Gate source voltage	V_{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	100 2.5	W	T _C =25 °C T _A =25 °C, R _{thJA} =60 °C/W ²⁾
Operating and storage temperature	T _j , T _{stg}	-55	-	175	°C	IEC climatic category; DIN IEC 68-1: 55/175/56

2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol		Values		Linis	Note / Test Condition
	Symbol	Min.	Тур.	Max.	-Unit	
Thermal resistance, junction - case, bottom	R_{thJC}	_	0.9	1.5	°C/W	-
Device on PCB, 6 cm² cooling area	R _{thJA}	-	-	60	°C/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature environmental conditions.

2) Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed in as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual

See Diagram 3 for more detailed information

⁴⁾ See Diagram 13 for more detailed information

OptiMOS[™] 5 Power-Transistor, 80 V IQE050N08NM5



3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Table 4 **Static characteristics**

Danier dan	O		Values			N 4 7 4 2 13
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	80	-	-	V	V _{GS} =0 V, I _D =1 mA
Gate threshold voltage	V _{GS(th)}	2.2	3.0	3.8	V	$V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=49\ \mu {\rm A}$
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1.0 100	μA	V _{DS} =80 V, V _{GS} =0 V, T _i =25 °C V _{DS} =80 V, V _{GS} =0 V, T _i =125 °C
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	4.3 6.1	5.0 8.5	mΩ	V _{GS} =10 V, I _D =20 A V _{GS} =6 V, I _D =5 A
Gate resistance	R _G	-	0.8	-	Ω	-
Transconductance	g_{fs}	38	75	-	S	$ V_{DS} \ge 2 I_D R_{DS(on)max}, I_D = 45 A$

 Table 5
 Dynamic characteristics

Parameter	Symbol	Values			11:4	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance ¹⁾	C _{iss}	-	2200	2900	pF	V _{GS} =0 V, V _{DS} =40 V, f=1 MHz
Output capacitance ¹⁾	Coss	-	370	480	pF	V _{GS} =0 V, V _{DS} =40 V, f=1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	21	37	pF	V _{GS} =0 V, V _{DS} =40 V, f=1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	9.4	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω
Rise time	t _r	-	4.6	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	$t_{ m d(off)}$	-	16.1	-	ns	V_{DD} =40 V, V_{GS} =10 V, I_{D} =20 A, $R_{G,ext}$ =1.6 Ω
Fall time	t _f	-	4.0	-	ns	V_{DD} =40 V, V_{GS} =10 V, I_{D} =20 A, $R_{G,ext}$ =1.6 Ω

Gate charge characteristics²⁾ Table 6

Davamatar	Sumb al	Values			11:4	Note / Took Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	10	-	nC	V_{DD} =40 V, I_{D} =20 A, V_{GS} =0 to 10 V
Gate charge at threshold	$Q_{g(th)}$	-	6.7	-	nC	V_{DD} =40 V, I_{D} =20 A, V_{GS} =0 to 10 V
Gate to drain charge ¹⁾	$Q_{ m gd}$	-	8.8	13	nC	$V_{\rm DD}$ =40 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 10 V
Switching charge	Q _{sw}	-	12	-	nC	V_{DD} =40 V, I_{D} =20 A, V_{GS} =0 to 10 V
Gate charge total ¹⁾	Q_{g}	-	34.6	43.2	nC	V _{DD} =40 V, I _D =20 A, V _{GS} =0 to 10 V
Gate plateau voltage	V _{plateau}	-	4.5	-	V	V_{DD} =40 V, I_{D} =20 A, V_{GS} =0 to 10 V
Gate charge total, sync. FET	$Q_{g(sync)}$	-	28.7	-	nC	V _{DS} =0.1 V, V _{GS} =0 to 10 V
Output charge ¹⁾	Qoss	_	40	53	nC	V _{DS} =40 V, V _{GS} =0 V

Defined by design. Not subject to production test.
See "Gate charge waveforms" for parameter definition

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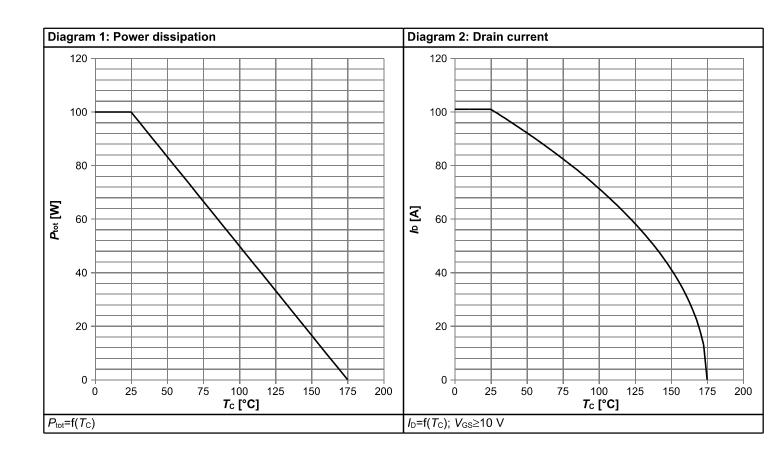


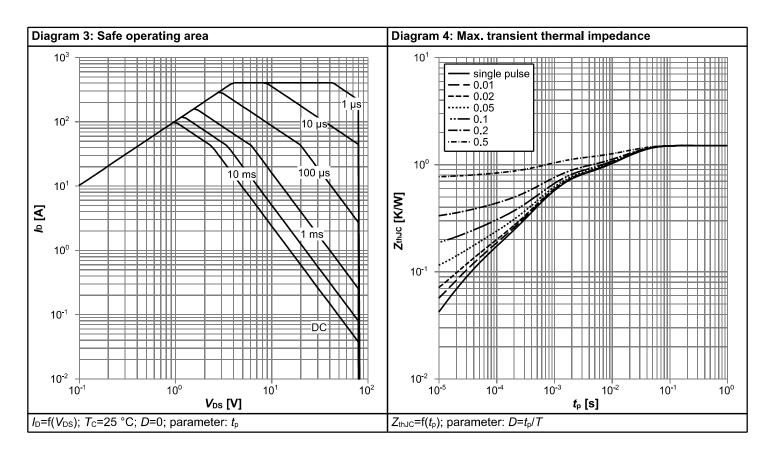
Table 7 Reverse diode

Devenuetos	Cymah al		Values			Note / Total Constitution
Parameter	Symbol	Symbol Min. Typ. Max.	Unit	Note / Test Condition		
Diode continuous forward current	Is	-	-	76	Α	T _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	404	Α	T _C =25 °C
Diode forward voltage	V _{SD}	-	0.83	1.1	V	V _{GS} =0 V, I _F =20 A, T _j =25 °C
Reverse recovery time ¹⁾	<i>t</i> _{rr}	-	37	74	ns	V _R =40 V, I _F =20 A, di _F /dt=100 A/μs
Reverse recovery charge ¹⁾	Q _{rr}	_	30	60	nC	V _R =40 V, I _F =20 A, di _F /dt=100 A/μs

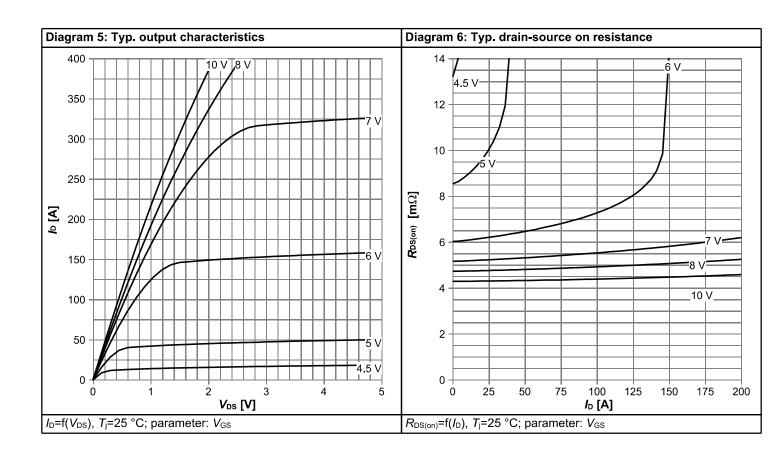


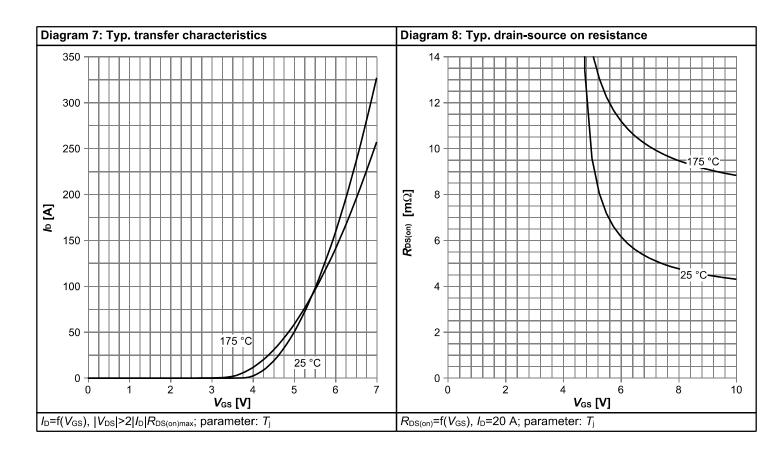
4 Electrical characteristics diagrams



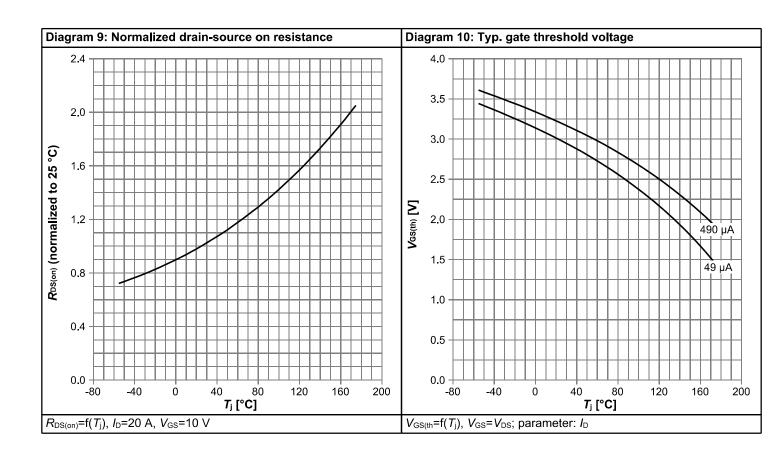


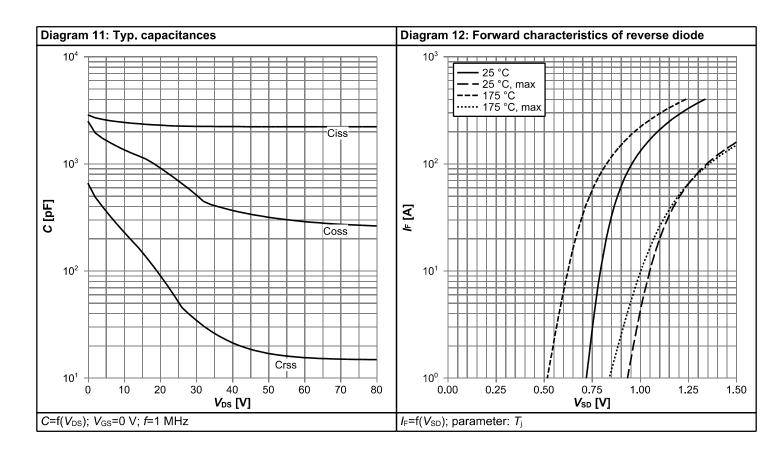




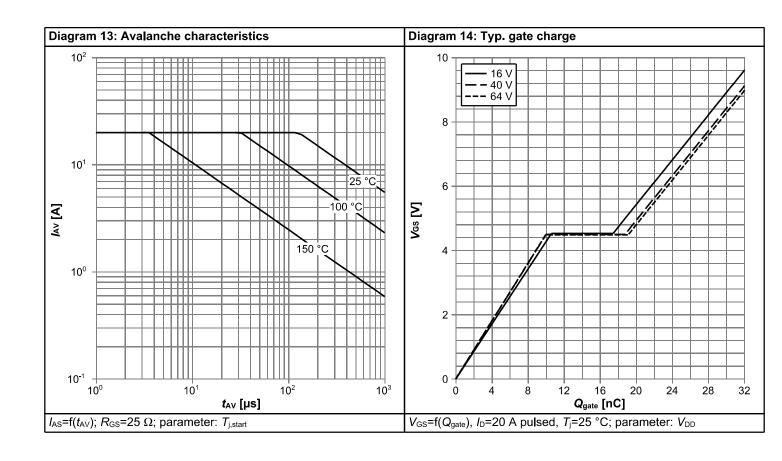


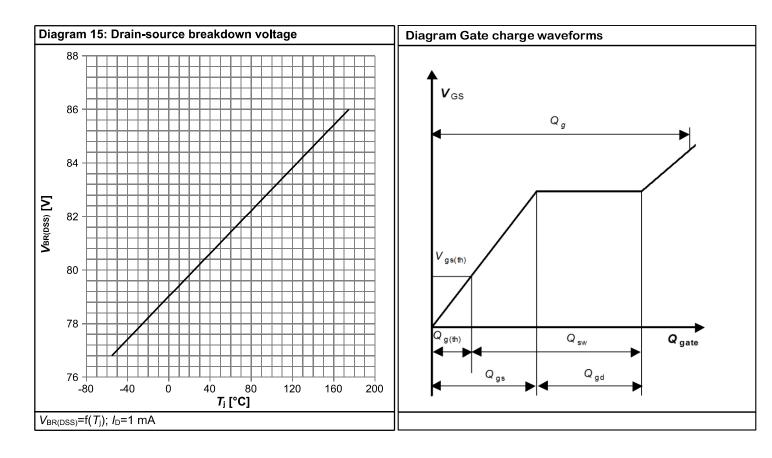






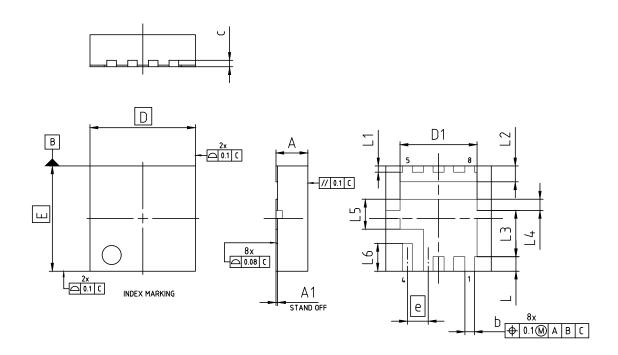








5 Package Outlines



DIMENSION	MILLIM	MILLIMETERS						
DIMENSION	MIN.	MAX.						
Α	-	1.10						
A1	-	0.05						
b	0.20	0.40						
С	0.	20						
D	3.30							
D1	2.31	2.51						
E	3.30							
е	0.	65						
L	0.35	0.55						
L1	0.10	0.30						
L2	0.40	0.60						
L3	1.35	1.55						
L4	0.26 0.46							
L5	0.84 1.04							
L6	0.77	0.97						

DOCUMENT NO. Z8B00198723				
REVISION 01				
SCALE 10:1				
0 1 2mm Luuuuuluuuuul				
EUROPEAN PROJECTION				
ISSUE DATE 06.11.2019				

Figure 1 Outline PG-TSON-8-4, dimensions in mm



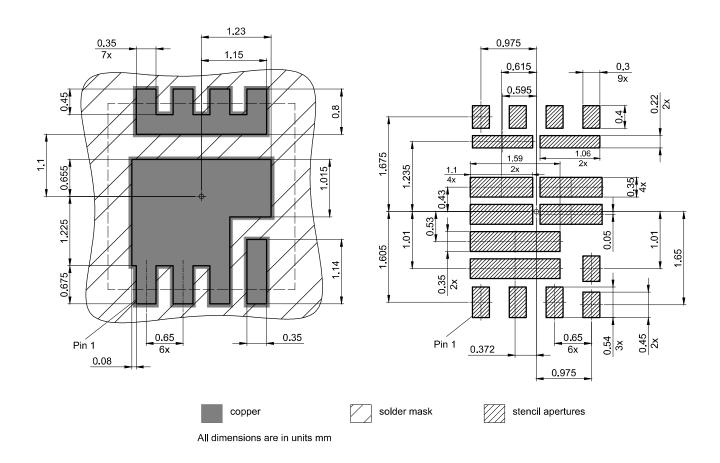


Figure 2 Outline Boardpad (PG-TSON-8-4)

OptiMOS[™] 5 Power-Transistor, 80 V IQE050N08NM5



Revision History

IQE050N08NM5

Revision: 2021-04-26, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.0	2021-04-26	Release of final version

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